

Fast CMOS 3.3V 8-Bit **Buffer/Line Driver**

Product Features

- Compatible with LCXTM and LVTTM families of products
- Supports 5V I/O Tolerant Mixed-Signal Mode Operation
 - Input can be 3V or 5V
 - Output can be 3V or connected to 5V bus
- Advanced Low-Power CMOS Operation
- Excellent output drive capability: Balanced drives (24mA sink and source)
- Low ground bounce outputs
- Hysteresis on all inputs
- Industrial operating temperature range: -40°C to +85°C
- Packages available:
 - -20-pin 173 mil wide plastic TSSOP(L)
 - -20-pin 150 mil wide plastic QSOP(Q)
 - -20-pin 150 mil wide plastic TQSOP(R)
 - -20-pin 300 mil wide plastic SOIC (S)

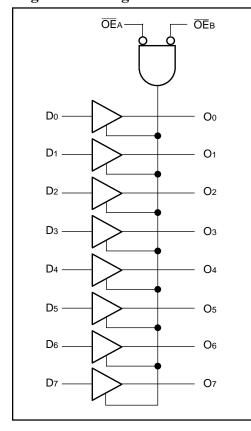
Product Description

Pericom Semiconductor's PI74LPT series of logic circuits are produced using the Company's advanced 0.6 micron CMOS technology, achieving industry leading speed grades.

The PI74LPT541 is an 8-bit buffer/line driver designed for driving high-capacitive memory loads. With its balanced-drive characteristics, this high-speed, low-power device provides lower ground bounce, transmission line matching of signals, fewer line reflections, and lower EMI and RFI effects. This makes it ideal for driving on-board buses and transmission lines. This device offers a flow-through organization for ease of board layout.

The PI74LPT541, which can be driven from either 3.3V or 5.0V devices, can be used as a translator in mixed 3.3/5.0V systems.

Logic Block Diagram



Product Pin Configuration

OEA □ 1 20 □ Vcc D0 □ 2 19 □ OEB D1 □ 3 18 □ O0 D2 □ 4 20-PIN 17 □ O1 D3 □ 5 L20 16 □ O2 D4 □ 6 Q20 15 □ O3 D5 □ 7 R20 14 □ O4 D6 □ 8 13 □ O5 D7 □ 9 12 □ O6 GND □ 10 11 □ O7

Product Pin Description

Description
3-State Output Enable
Inputs (Active LOW)
Inputs
Outputs
Ground
Power

Truth Table(1)

	Outputs		
OE A	ОEв	Dx	Ox
L	L	L	L
L	L	Н	Н
Н	Н	X	Z

Notes:

1. H = High Voltage Level, X = Don't Care, L = Low Voltage Level, Z = High Impedance

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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature65°C to +150°C
Ambient Temperature with Power Applied—40°C to +85°C
Supply Voltage to Ground Potential (Inputs & Vcc Only)0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only)0.5V to +7.0V
DC Input Voltage0.5V to +7.0V
DC Output Current
Power Dissipation

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, $TA = -40^{\circ}C$ to $+85^{\circ}C$, VCC = 2.7V to 3.6V)

Parameters	Description	Test Condit	Min.	Typ ⁽²⁾	Max.	Units	
VIH	Input HIGH Voltage (Input pins)	Guaranteed Logic HIGH I	2.2	_	5.5	V	
	Input HIGH Voltage (I/O pins)		2.0	_	5.5	V	
VIL	Input LOW Voltage	Guaranteed Logic LOW L	Level	-0.5	_	0.8	V
	(Input and I/O pins)	_					
Іін	Input HIGH Current (Input pins)	$V_{CC} = Max.$	$V_{IN} = 5.5V$	_	_	±1	μΑ
	Input HIGH Current (I/O pins)	$V_{CC} = Max.$	$V_{IN} = V_{CC}$	_	_	±1	μΑ
IIL	Input LOW Current (Input pins)	$V_{CC} = Max.$	$V_{IN} = GND$	_	_	±1	μΑ
	Input LOW Current (I/O pins)	$V_{CC} = Max.$	Vin = GND	_	_	±1	μΑ
Iozн	High Impedance Output Current	$V_{CC} = Max.$	$V_{OUT} = 5.5V$	_	_	±1	μΑ
Iozl	(3-State Output pins)	$V_{CC} = Max.$	$V_{CC} = Max.$ $V_{OUT} = GND$			±1	μΑ
Vik	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18mA$	_	-0.7	-1.2	V	
Іорн	Output HIGH Current	$V_{CC} = 3.3V$, $V_{IN} = V_{IH}$ or	-36	-60	-110	mA	
Iodl	Output LOW Current	$V_{CC} = 3.3V$, $V_{IN} = V_{IH}$ or	$V_{CC} = 3.3V$, $V_{IN} = V_{IH}$ or V_{IL} , $V_{O} = 1.5V^{(3)}$			200	mA
Vон	Output HIGH Voltage	Vcc = Min.	$I_{OH} = -0.1 \text{mA}$	Vcc-0.2	_	_	V
		$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -3mA$		2.4	3.0	_	V
		$V_{CC} = 3.0V,$	$V_{CC} = 3.0V$, $I_{OH} = -8mA$		3.0	_	V
		$V_{IN} = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -24 \text{mA}$	2.0	_	_	
Vol	Output LOW Voltage	Vcc = Min.	IoL = 0.1 mA	_	_	0.2	V
		$V_{IN} = V_{IH} \text{ or } V_{IL}$	IoL = 16mA	_	0.2	0.4	V
			IoL = 24mA	_	0.3	0.5	V
Ios	Short Circuit Current ⁽⁴⁾	$V_{CC} = Max.^{(3)}, V_{OUT} = GN$		-60	-85	-240	
mA							
Ioff	Power Down Disable	$V_{CC} = 0V$, V_{IN} or $V_{OUT} \le$	_	_	±100	μA	
Notes:	Input Hysteresis			_	150	_	mV

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 3.3V, +25°C ambient and maximum loading.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. This parameter is guaranteed but not tested.
- 5. VoH = Vcc 0.6V at rated current.

Capacitance ($T_A = 25^{\circ}C$, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Тур.	Max.	Units
Cin	Input Capacitance	$V_{IN} = 0V$	4.5	6	pF
Соит	Output Capacitance	$V_{OUT} = 0V$	5.5	8	pF

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1. This parameter is determined by device characterization but is not production tested.



Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾			Typ. ⁽²⁾	Max.	Units
Icc	Quiescent Power Supply Current	$V_{CC} = Max.$	VIN = GND or VCC		0.1	10	μΑ
ΔΙcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max.	$V_{\rm IN} = V_{\rm CC} - 0.6V^{(3)}$		_	100	
Іссь	Dynamic Power Supply ⁽⁴⁾	Vcc = Max., Outputs Open $\overline{OE}x = GND$ One Bit Toggling 50% Duty Cycle	Vin = Vcc Vin = GND		50	75	μA/ MHz
Ic	Total Power Supply Current ⁽⁶⁾	$Vcc = Max.,$ Outputs Open $fi = 10 \text{ MHz}$ $50\% \text{ Duty Cycle}$ $\overline{OEx} = GND$ One Bit Toggling	$V_{IN} = V_{CC} - 0.6V$ $V_{IN} = GND$		0.6	2.3	mA
		Vcc = Max., Outputs Open fi = 2.5 MHz 50% Duty Cycle $\overline{OE}x = GND$ 8 Bits Toggling	Vin = Vcc – 0.6V Vin = GND		2.1	4.7 ⁽⁵⁾	

Notes:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at Vcc = 3.3V, +25°C ambient.
- 3. Per TTL driven input; all other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the Icc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
 - $IC = ICC + \Delta ICC DHNT + ICCD (fCP/2 + fiNi)$
 - Icc = Quiescent Current (Iccl, Icch and Iccz)
 - ΔIcc = Power Supply Current for a TTL High Input
 - DH = Duty Cycle for TTL Inputs High
 - N_T = Number of TTL Inputs at D_H
 - ICCD = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)
 - fcp = Clock Frequency for Register Devices (Zero for Non-Register Devices)
 - NCP = Number of Clock Inputs at fCP
 - fi = Input Frequency
 - $N_I = Number of Inputs at fi$
 - All currents are in milliamps and all frequencies are in megahertz.



Switching Characteristics over Operating Range⁽¹⁾

			LPT541 LPT541A		LPT5	41C			
			Com.		Com.		Com.		
Parameters	Description	$\boldsymbol{Conditions}^{(2)}$	Min.(3)	Max.	Min.(3)	Max.	Min.(3)	Max.	Units
tPLH tPHL	Propagation Delay Dx to Ox	$C_L = 50pF$ $R_L = 500\Omega$	1.5	6.0	1.5	4.8	1.5	4.1	
tpzh tpzl	Output Enable Time OEx to Ox		1.5	9.5	1.5	6.2	1.5	5.8	ns
tPHZ tPLZ	Output Disable Time ⁽⁴⁾ OEx to Ox		1.5	6.5	1.5	5.6	1.5	5.2	
tsk(o)	Output Skew ⁽⁵⁾			0.5		0.5		0.5	

Notes:

- 1. Propagation Delays and Enable/Disable times are with $Vcc = 3.3V \pm 0.3V$, normal range. For Vcc = 2.7V, extended range, all Propagation Delays and Enable/Disable times should be degraded by 20%.
- 2. See test circuit and waveforms.
- 3. Minimum limits are guaranteed but not tested on Propagation Delays.
- 4. This parameter is guaranteed but not production tested.
- 5. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.